

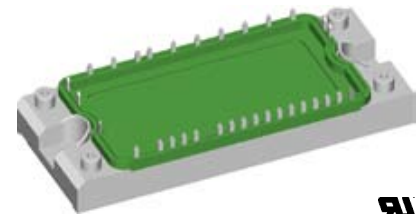
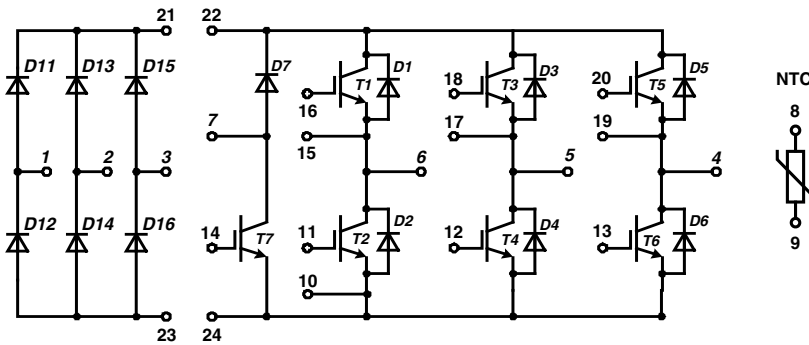
# Converter - Brake - Inverter Module XPT IGBT

Single Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM25} = 150 \text{ A}$	$I_{C25} = 17 \text{ A}$	$I_{C25} = 17 \text{ A}$
$I_{FSM} = 320 \text{ A}$	$V_{CE(sat)} = 1.8 \text{ V}$	$V_{CE(sat)} = 1.8 \text{ V}$

Preliminary data

**Part name** (Marking on product)

MIXA10WB1200TED



  
E 72873

Pin configuration see outlines.

## Features:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low  $V_{CE(sat)}$
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

## Application:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies

## Package:

- "E2-Pack" standard outline
- Insulated copper base plate
- Soldering pins for PCB mounting
- Temperature sense included

## Output Inverter T1 - T6

Symbol	Definitions	Conditions	Ratings			Unit	
			min.	typ.	max.		
$V_{CES}$	collector emitter voltage				1200	V	
$V_{GES}$	max. DC gate voltage	continuous			±20	V	
$V_{GEM}$	max. transient collector gate voltage	transient			±30	V	
$I_{C25}$	collector current		$T_C = 25^\circ\text{C}$		17	A	
$I_{C80}$			$T_C = 80^\circ\text{C}$		12	A	
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		60	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 9\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.8 2.1	2.1	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3\text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5.5	6.0	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.01 0.1	0.7	mA mA	
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 10\text{ A}$			27	nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 10\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 100\ \Omega$	$T_{VJ} = 125^\circ\text{C}$	70		ns	
$t_r$	current rise time			40		ns	
$t_{d(off)}$	turn-off delay time			250		ns	
$t_f$	current fall time			100		ns	
$E_{on}$	turn-on energy per pulse			1.1		mJ	
$E_{off}$	turn-off energy per pulse			1.1		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 100\ \Omega;$	$T_{VJ} = 125^\circ\text{C}$ $V_{CEK} = 1200\text{ V}$		30	A	
<b>SCSOA</b>	short circuit safe operating area		$T_{VJ} = 125^\circ\text{C}$		10	$\mu\text{s}$	
$t_{SC}$	short circuit duration	$V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V};$			40	A	
$I_{SC}$	short circuit current	$R_G = 100\ \Omega;$ non-repetitive					
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			2.0	K/W	

## Output Inverter D1 - D6

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^\circ\text{C}$		1200	V
$I_{F25}$	forward current		$T_C = 25^\circ\text{C}$		19	A
$I_{F80}$			$T_C = 80^\circ\text{C}$		13	A
$V_F$	forward voltage	$I_F = 10\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.95 1.85	2.2	V V
$Q_{rr}$	reverse recovery charge	$V_R = 600\text{ V}$ $di_F/dt = -\text{ A}/\mu\text{s}$ $I_F = 10\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 125^\circ\text{C}$	tbd		$\mu\text{C}$
$I_{RM}$	max. reverse recovery current			tbd		A
$t_{rr}$	reverse recovery time			tbd		ns
$E_{rec}$	reverse recovery energy			tbd		mJ
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.4	K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

## Brake T7

Symbol	Definitions	Conditions	Ratings			Unit	
			min.	typ.	max.		
$V_{CES}$	collector emitter voltage		$T_{VJ} = 25^{\circ}\text{C}$		1200	V	
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V	
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V	
$I_{C25}$	collector current		$T_C = 25^{\circ}\text{C}$		17	A	
$I_{C80}$			$T_C = 80^{\circ}\text{C}$		12	A	
$P_{tot}$	total power dissipation		$T_C = 25^{\circ}\text{C}$		60	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 9\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.8 2.1	2.1	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3\text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^{\circ}\text{C}$	5.5	6.0	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		0.1	0.1	mA mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 10\text{ A}$			27	nC	
$t_{d(on)}$	turn-on delay time	} inductive load $V_{CE} = 600\text{ V}; I_C = 10\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 100\ \Omega$	$T_{VJ} = 125^{\circ}\text{C}$		70	ns	
$t_r$	current rise time				40	ns	
$t_{d(off)}$	turn-off delay time				250	ns	
$t_f$	current fall time				100	ns	
$E_{on}$	turn-on energy per pulse				1.1	mJ	
$E_{off}$	turn-off energy per pulse				1.1	mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 100\ \Omega;$	$T_{VJ} = 125^{\circ}\text{C}$ $V_{CEK} = 1200\text{ V}$		30	A	
<b>SCSOA</b>	short circuit safe operating area						
$t_{SC}$	short circuit duration	$V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V};$	$T_{VJ} = 125^{\circ}\text{C}$		10	$\mu\text{s}$	
$I_{SC}$	short circuit current	$R_G = 100\ \Omega;$ non-repetitive		40		A	
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			2.0	K/W	

## Brake Chopper D7

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}\text{C}$		1200	V
$I_{F25}$	forward current		$T_C = 25^{\circ}\text{C}$		12	A
$I_{F80}$			$T_C = 80^{\circ}\text{C}$		8	A
$V_F$	forward voltage	$I_F = 5\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.95 1.85	2.2	V V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		0.5	0.5 mA mA
$Q_{rr}$	reverse recovery charge	} $V_R = 600\text{ V}$ $di_F/dt = \text{tbd A}/\mu\text{s}$ $I_F = 10\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 125^{\circ}\text{C}$		tbd	$\mu\text{C}$
$I_{RM}$	max. reverse recovery current				tbd	A
$t_{rr}$	reverse recovery time				tbd	ns
$E_{rec}$	reverse recovery energy				tbd	$\mu\text{J}$
$R_{thJC}$	thermal resistance junction to case	(per diode)			3.4	K/W

 $T_C = 25^{\circ}\text{C}$  unless otherwise stated

## Input Rectifier Bridge D11 - D16

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}\text{C}$		1600	V
$I_{FAV}$	average forward current	sine $180^{\circ}$	$T_C = 80^{\circ}\text{C}$		37	A
$I_{DAVM}$	max. average DC output current	rect.; $d = 1/3$	$T_C = 80^{\circ}\text{C}$		105	A
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}$ ; sine 50 Hz	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		320 280	A A
$I^2t$	$I^2t$ value for fusing	$t = 10\text{ ms}$ ; sine 50 Hz	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		510 390	$\text{A}^2\text{s}$ $\text{A}^2\text{s}$
$P_{tot}$	total power dissipation		$T_C = 25^{\circ}\text{C}$		110	W
$V_F$	forward voltage	$I_F = 50\text{ A}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.34 1.34	1.7	V V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	0.2	0.02	mA mA
$R_{thJC}$	thermal resistance junction to case	(per diode)			1.1	K/W

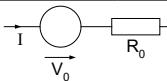
## Temperature Sensor NTC

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$R_{25}$	resistance		$T_C = 25^{\circ}\text{C}$	4.75	5.0	$\text{k}\Omega$
$B_{25/50}$					3375	K

## Module

Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$T_{VJ}$	operating temperature		-40		125	$^{\circ}\text{C}$
$T_{VJM}$	max. virtual junction temperature				150	$^{\circ}\text{C}$
$T_{stg}$	storage temperature		-40		125	$^{\circ}\text{C}$
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1\text{ mA}$ ; 50/60 Hz			2500	V~
CTI	comparative tracking index				-	
$M_d$	mounting torque (M5)		3		6	Nm
$d_S$	creep distance on surface		6			mm
$d_A$	strike distance through air		6			mm
$R_{pin-chip}$	resistance pin to chip			5		$\text{m}\Omega$
$R_{thCH}$	thermal resistance case to heatsink	with heatsink compound		0.02		K/W
Weight				180		g

## Equivalent Circuits for Simulation



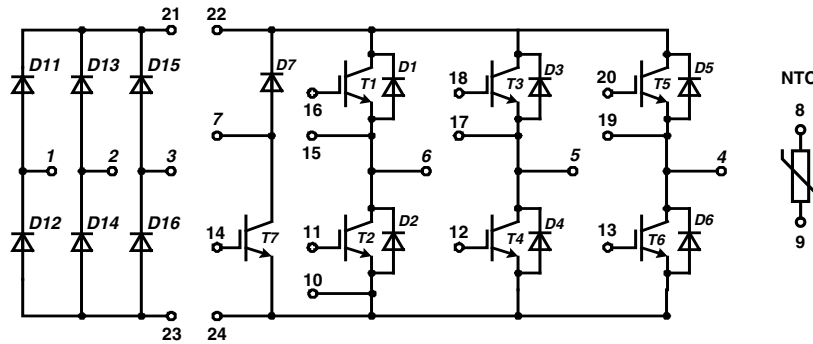
Symbol	Definitions	Conditions	Ratings			Unit
			min.	typ.	max.	
$V_0$	rectifier diode	D8 - D13	$T_{VJ} = 150^{\circ}\text{C}$		0.88	V
$R_0$					9	$\text{m}\Omega$
$V_0$	IGBT	T1 - T6	$T_{VJ} = 150^{\circ}\text{C}$		1.1	V
$R_0$					153	$\text{m}\Omega$
$V_0$	free wheeling diode	D1 - D6	$T_{VJ} = 150^{\circ}\text{C}$		1.1	V
$R_0$					90	$\text{m}\Omega$
$V_0$	IGBT	T7	$T_{VJ} = 150^{\circ}\text{C}$		1.1	V
$R_0$					153	$\text{m}\Omega$
$V_0$	free wheeling diode	D7	$T_{VJ} = 150^{\circ}\text{C}$		1.15	V
$R_0$					170	$\text{m}\Omega$

 $T_C = 25^{\circ}\text{C}$  unless otherwise stated

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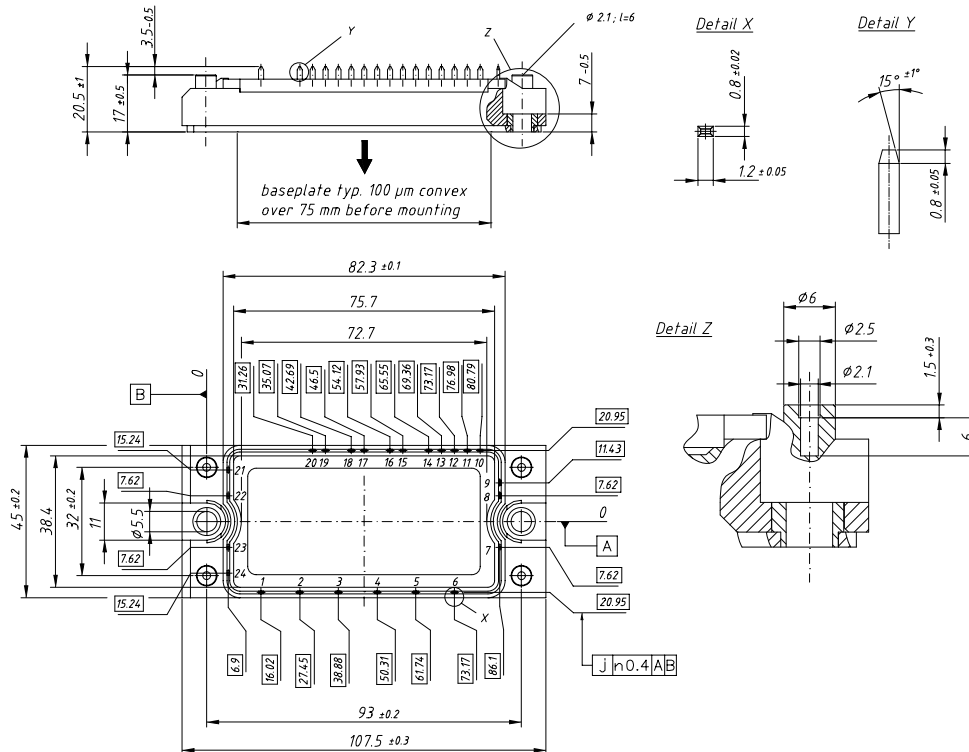
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## Circuit Diagram



## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking



### Part number

- M = Module
- I = IGBT
- A = MPT
- X = Parallel Legs
- 10 = Current Rating [A]
- WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit
- 1200 = Reverse Voltage [V]
- T = NTC
- ED = E2-Pack

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIXA10WB1200 TED	MIXA10WB1200TED	Box	6	508061

IXYS reserves the right to change limits, test conditions and dimensions.

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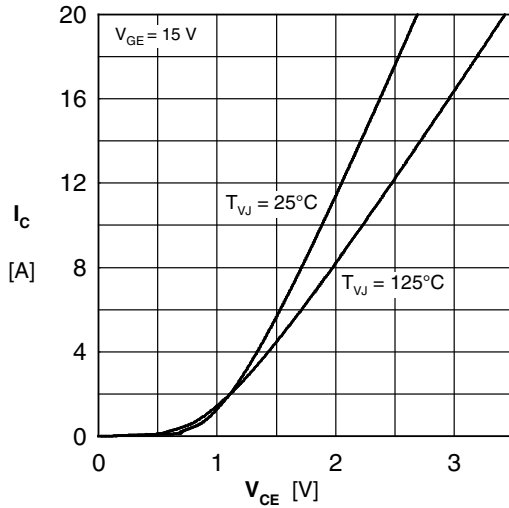


Fig. 1 Typ. output characteristics

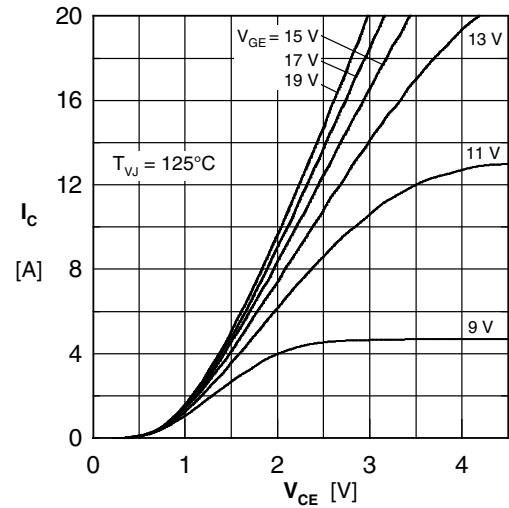


Fig. 2 Typ. output characteristics

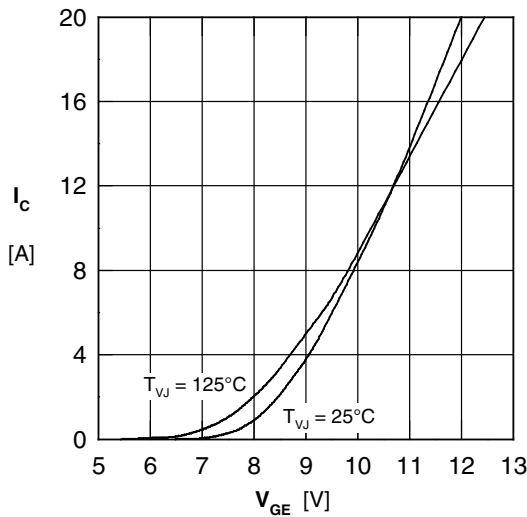


Fig. 3 Typ. transfer characteristics

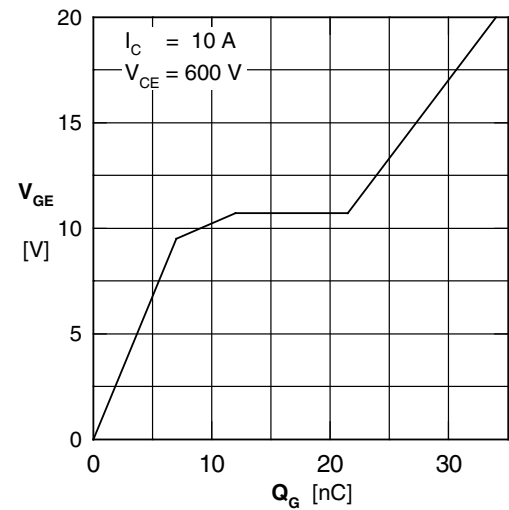


Fig. 4 Typ. turn-on gate charge

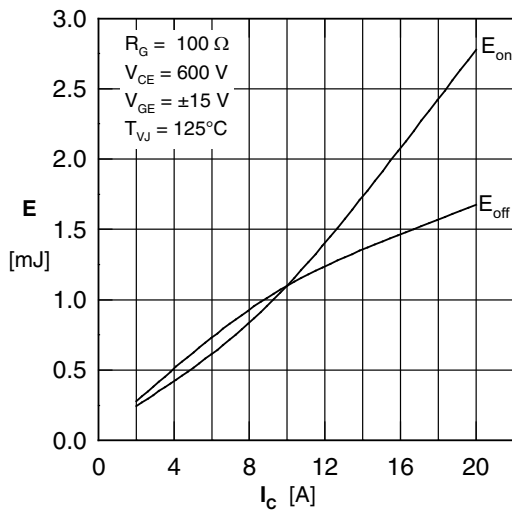


Fig. 5 Typ. switching energy vs. collector current

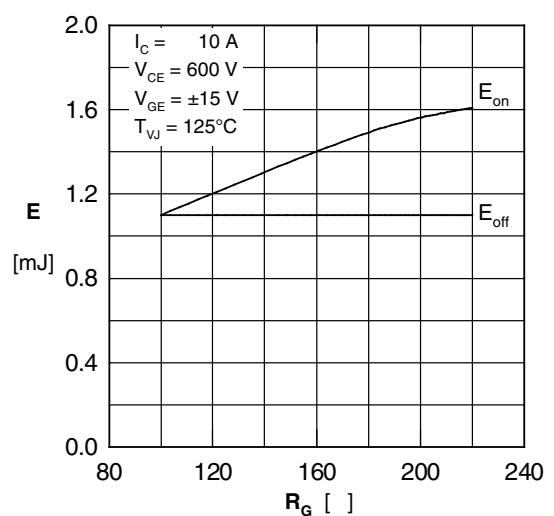


Fig. 6 Typ. switching energy vs. gate resistance

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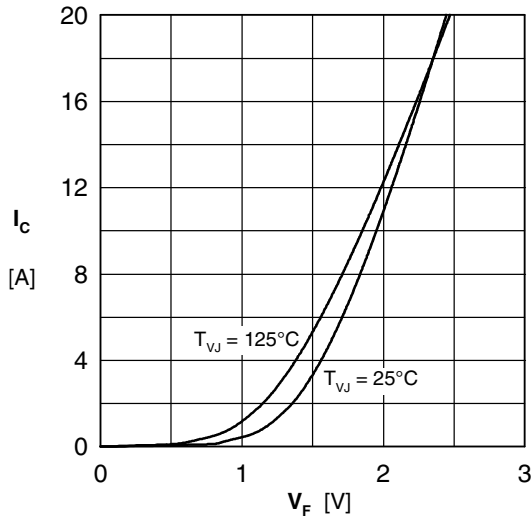


Fig. 7 Typ. forward characteristic

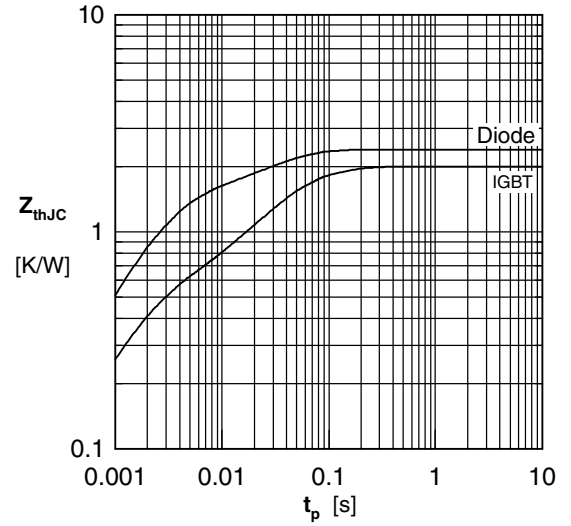


Fig. 8 Transient thermal impedance

	IGBT		FRD	
	$R_i$	$\tau_i$	$R_i$	$\tau_i$
1	0.446	0.0015	0.8	0.002
2	0.415	0.03	0.58	0.03
3	0.672	0.03	0.98	0.03
4	0.467	0.08	0.04	0.08